

# SN54ABT162540, SN74ABT162540 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS244 – JULY 1993

- Output Ports Have Equivalent 25-Ω Series Resistors, So No External Resistors Are Required
- Members of the Texas Instruments *Widebus*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Packaged in Plastic 300-mil Shrink Small-Outline Packages and 380-mil Fine-Pitch Ceramic Flat Packages Using 25-mil Center-to-Center Spacings

## description

These 16-bit buffers and bus drivers provide a high-performance bus interface for wide data paths.

The 3-state control gate is a 2-input AND gate with active-low inputs so that if either output-enable ( $\overline{OE1}$  or  $\overline{OE2}$ ) input is high, all corresponding outputs are in the high-impedance state.

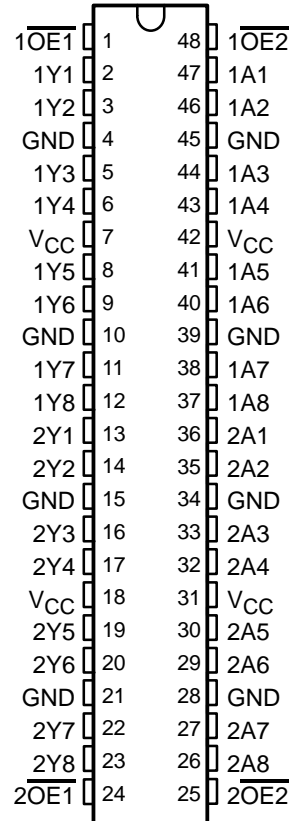
The outputs, which are designed to source or sink up to 12 mA, include 25-Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT162540 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT162540 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT162540 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

SN54ABT162540 . . . WD PACKAGE  
SN74ABT162540 . . . DL PACKAGE  
(TOP VIEW)



FUNCTION TABLE  
(each 8-bit section)

INPUTS			OUTPUT Y
$\overline{OE1}$	$\overline{OE2}$	A	
L	L	L	H
L	L	H	L
H	X	X	Z
X	H	X	Z

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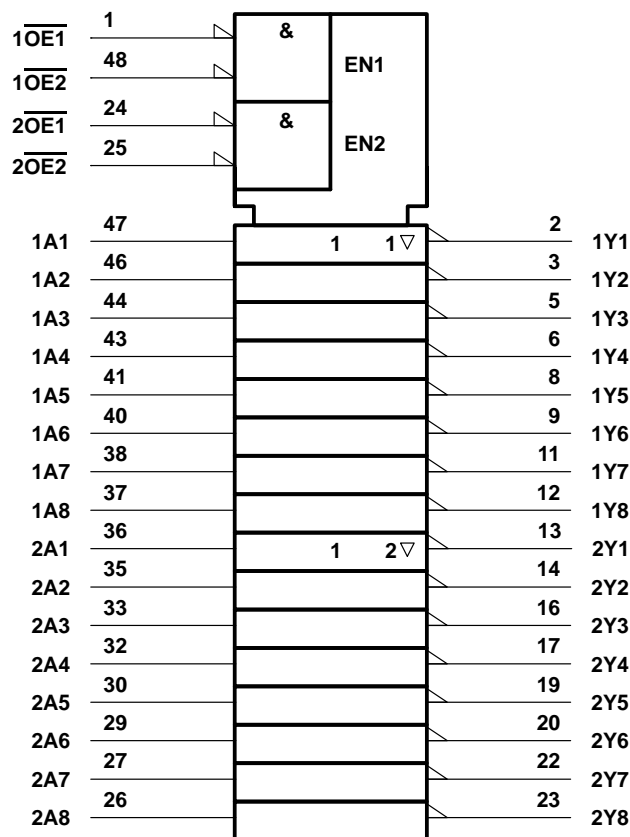
# SN54ABT162540, SN74ABT162540

## 16-BIT BUFFERS/DRIVERS

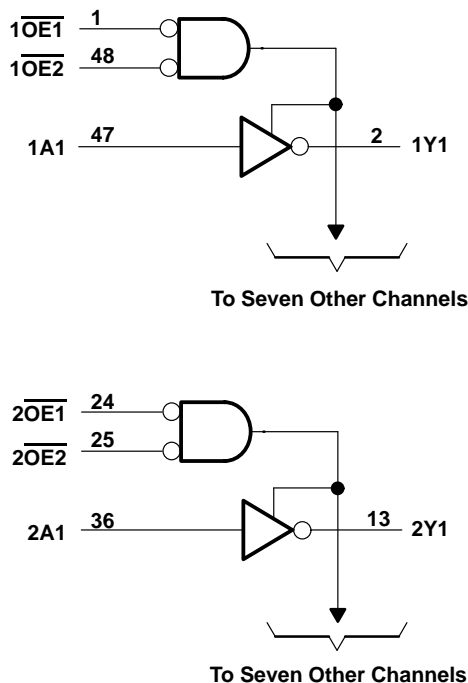
### WITH 3-STATE OUTPUTS

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#### logic symbol†



#### logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$	30 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air)	0.85 W
Storage temperature range	–65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

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**SN54ABT162540, SN74ABT162540**  
**16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

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**recommended operating conditions (see Note 2)**

			SN54ABT162540		SN74ABT162540		UNIT
			MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage		4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage		2		2		V
$V_{IL}$	Low-level input voltage			0.8		0.8	V
$V_I$	Input voltage		0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current			–12		–12	mA
$I_{OL}$	Low-level output current			12		12	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$T_A$	Operating free-air temperature		–55	125	–40	85	°C

NOTE 2: Unused or floating inputs must be held high or low.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS		$T_A = 25^\circ\text{C}$			SN54ABT162540		SN74ABT162540		UNIT
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
$V_{IK}$	$V_{CC} = 4.5\text{ V}$ , $I_I = -18\text{ mA}$				–1.2		–1.2		–1.2	V
$V_{OH}$	$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -1\text{ mA}$		3.35			3.3		3.35		V
	$V_{CC} = 5\text{ V}$ , $I_{OH} = -1\text{ mA}$		3.85			3.8		3.85		
	$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -3\text{ mA}$		3.1			3		3.1		
	$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -12\text{ mA}$		2.6‡					2.6		
$V_{OL}$	$V_{CC} = 4.5\text{ V}$ , $I_{OL} = 8\text{ mA}$			0.4	0.8		0.8		0.65	V
	$V_{CC} = 4.5\text{ V}$ , $I_{OL} = 12\text{ mA}$								0.8	
$I_I$	$V_{CC} = 5.5\text{ V}$ , $V_I = V_{CC}$ or GND				$\pm 1$		$\pm 1$		$\pm 1$	$\mu\text{A}$
$I_{OZH}^\S$	$V_{CC} = 5.5\text{ V}$ , $V_O = 2.7\text{ V}$				50		50		50	$\mu\text{A}$
$I_{OZL}^\S$	$V_{CC} = 5.5\text{ V}$ , $V_O = 0.5\text{ V}$				–50		–50		–50	$\mu\text{A}$
$I_{off}$	$V_{CC} = 0$ , $V_I$ or $V_O \leq 4.5\text{ V}$				$\pm 100$				$\pm 100$	$\mu\text{A}$
$I_{CEX}$	$V_{CC} = 5.5\text{ V}$ , $V_O = 5.5\text{ V}$	Outputs high			50		50		50	$\mu\text{A}$
$I_O^\P$	$V_{CC} = 5.5\text{ V}$ , $V_O = 2.5\text{ V}$		–50	–100	–180	–50	–180	–50	–180	mA
$I_{CC}$	$V_{CC} = 5.5\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}$ or GND	Outputs high			2		2		2	mA
		Outputs low			32		32		32	
		Outputs disabled			2		2		2	
$\Delta I_{CC}^\#$	$V_{CC} = 5.5\text{ V}$ , One input at 3.4 V, Other inputs at $V_{CC}$ or GND	Data inputs			1		1.5		1	mA
		Outputs disabled			0.05		1		0.05	
		Control inputs			1.5		1.5		1.5	
$C_i$	$V_I = 2.5\text{ V}$ or $0.5\text{ V}$			7						pF
$C_o$	$V_O = 2.5\text{ V}$ or $0.5\text{ V}$			7						pF

† All typical values are at  $V_{CC} = 5\text{ V}$ .

‡ On products compliant to MIL-STD-883, Class B, this parameter does not apply.

§ The parameters  $I_{OZH}$  and  $I_{OZL}$  include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

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